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## ABSTRACT

A composition for polishing an aluminum, copper or tungsten film, which comprises water and a polishing agent selected from the group consisting of silicon  
5 dioxide, aluminum oxide, cerium oxide, silicon nitride and zirconium oxide, and which further contains an iron(III) compound dissolved in the composition, wherein the iron(III) compound is selected from the group consisting of iron(III) pyrophosphate, iron(III) citrate,  
10 iron(III) ammonium citrate, iron(III) ammonium oxalate, iron(III) ammonium sulfate, iron(III) perchlorate, iron(III) chloride, iron(III) sulfate and iron(III) phosphate.